UTC UNISONIC TECHNOLOGIES CO., LTD

10N80 **Power MOSFET**

10A, 800V N-CHANNEL **POWER MOSFET**

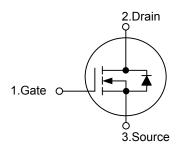
DESCRIPTION

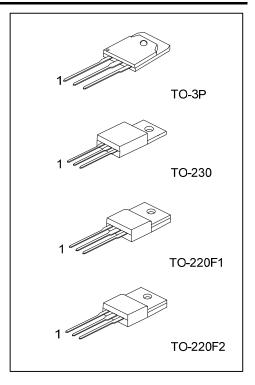
The UTC 10N80 uses UTC's advanced proprietary, planar stripe, DMOS technology to provide excellent R_{DS(ON)}, low gate charge and operation with low gate voltages. This device is suitable for use as a load switch or in PWM applications.

FEATURES

- * $R_{DS(ON)} < 1.1\Omega @V_{GS} = 10 V$
- * Ultra Low Gate Charge (Typical 45nC)
- * Low Reverse Transfer Capacitance (CRSS = Typical 15pF)
- * Fast Switching Capability
- * Avalanche Energy Specified
- * Improved dv/dt Capability, High Ruggedness

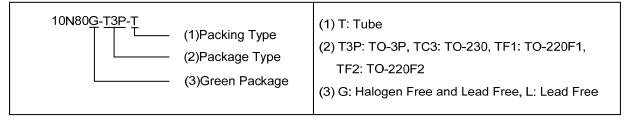
SYMBOL



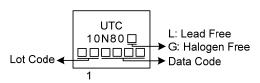


ORDERING INFORMATION

Ordering Number		Dackage	Pin Assignment			Dooking	
Lead Free	Halogen Free	Package	1	2	3	Packing	
10N80L-T3P-T	10N80G-T3P-T	TO-3P	G	D	S	Tube	
10N80L-TC3-T	10N80G-TC3-T	TO-230	G	D	S	Tube	
10N80L-TF1-T	10N80G-TF1-T	TO-220F1	G	D	S	Tube	
10N80L-TF2-T	10N80G-TF2-T	TO-220F2	G	D	S	Tube	



MARKING



■ ABSOLUTE MAXIMUM RATINGS (T_C =25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V _{DSS}	800	V	
Gate-Source Voltage		V _{GSS}	±30	V	
Continuous Drain Current (T _C = 25°C)		I _D	10	Α	
Pulsed Drain Current (Note 2)		I _{DM}	40	Α	
Avalanche Current (No	te 2)	I _{AR}	10	Α	
Avalancha Energy	Single Pulsed (Note 3)	E _{AS}	920	mJ	
Avalanche Energy	Repetitive (Note 2)	E _{AR}	24	mJ	
Peak Diode Recovery	Peak Diode Recovery dv/dt (Note 4)		4.0	V/ns	
	TO-3P		240		
Dower Dissipation	TO-230		156	W	
Power Dissipation	TO-220F1 TO-220F2	P _D	66		
	TO-3P		1.92	- W/°C	
Linear Derating Factor	above TO-230		1.25		
(T _C = 25°C)	TO-220F1 TO-220F2		0.528		
Junction Temperature		T _J	+150	°C	
Storage Temperature	rage Temperature		-55 ~ +150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive Rating : Pulse width limited by maximum junction temperature.
- 3. L=17.3mH, I_{AS} =10A, V_{DD} =50V, R_{G} =25 Ω , Starting T_{J} =25 $^{\circ}$ C
- 4. $I_{SD} \le 10$ A, di/dt ≤ 200 A/ μ s, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25$ °C

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT	
	TO-3P		40		
Junction to Ambient	TO-220F1	Δ		°C/W	
Junction to Ambient	TO-220F2	θ_{JA}	62.5	C/VV	
	TO-230				
	TO-3P		0.52	°C/W	
Junction to Case	TO-230	θ _{JC}	0.8		
Junction to Case	TO-220F1		4.00	C/VV	
	TO-220F2		1.89		

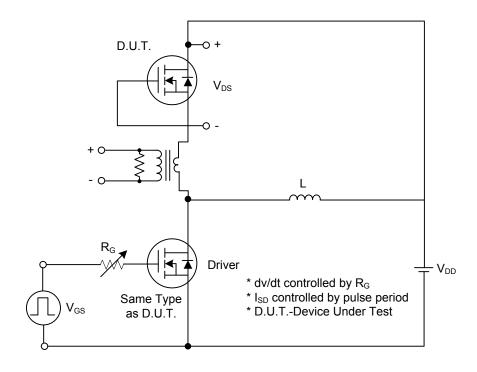
■ ELECTRICAL CHARACTERISTICS (T_J =25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT		
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage	BV _{DSS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	800			V		
Drain Source Leakage Current	I _{DSS}	V _{DS} =800V, V _{GS} =0 V			10			
Drain-Source Leakage Current		V _{DS} =640V, T _C =125°C			100	μΑ		
Gate-Body Leakage Current	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 30 \text{ V}$			±100	nA		
Breakdown Voltage Temperature Coefficient	$\Delta BV_{DSS}/\Delta T_{J}$	I _D =250μA, Referenced to 25°C		0.98		V/°C		
ON CHARACTERISTICS								
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$			5.0	V		
Static Drain-Source On-Resistance	R _{DS(ON)}	$V_{GS} = 10V, I_D = 5.0A$		0.9	1.1	Ω		
DYNAMIC PARAMETERS								
Input Capacitance	C _{ISS}	V _{DS} =25V, V _{GS} =0V,		2150	2800	pF		
Output Capacitance	Coss	f=1MHz		180	230	pF		
Reverse Transfer Capacitance	C _{RSS}			15	20	pF		
SWITCHING PARAMETERS								
Total Gate Charge	Q_G	-V _{DS} =640V, V _{GS} =10V, -I _D =10.0A (Note 1,2)		45	58			
Gate Source Charge	Q_GS			13.5		nC		
Gate Drain Charge	Q_{GD}			17				
Turn-ON Delay Time	t _{D(ON)}			50	110			
Turn-ON Rise Time	t_R	V _{DD} =400V, I _D =10.0A,		130	270	ns		
Turn-OFF Delay Time	t _{D(OFF)}	R _G =25Ω (Note 1,2)		90	190			
Turn-OFF Fall-Time	t _F]		80	170			
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS								
Maximum Continuous Drain-Source Diode	I _S				10.0			
Forward Current	IS				10.0	Α		
Maximum Pulsed Drain-Source Diode	I _{SM}				40.0			
Forward Current	ISM							
Drain-Source Diode Forward Voltage	V _{SD}	I _S =10.0 A,V _{GS} =0V			1.4	V		
Reverse Recovery Time	t _{rr}	$V_{GS} = 0V$, $dI_F / dt = 100 A / \mu s$,		730		ns		
Reverse Recovery Charge	Q _{rr}	I _S = 10.0A (Note 1)		10.9		nC		

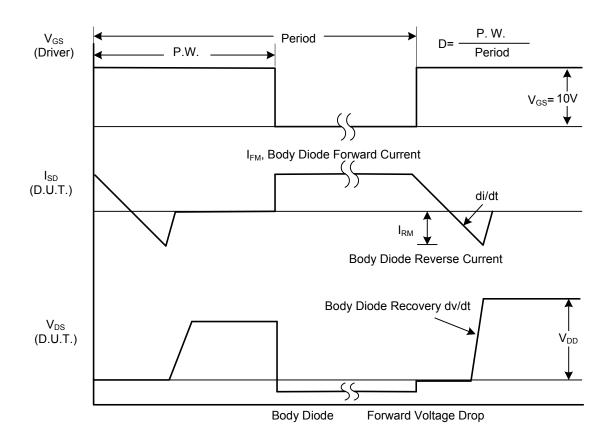
Notes: 1. Pulse Test: Pulse width \leq 250 μ s, Duty cycle \leq 2%.

^{2.} Essentially independent of operating temperature.

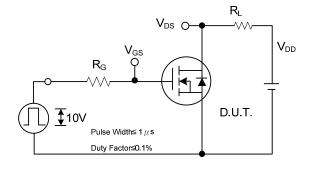
■ TEST CIRCUIT



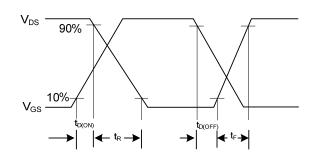
Peak Diode Recovery dv/dt Test Circuit



■ TEST CIRCUIT

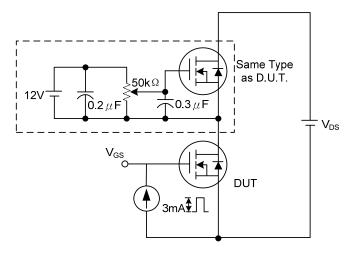


Switching Test Circuit

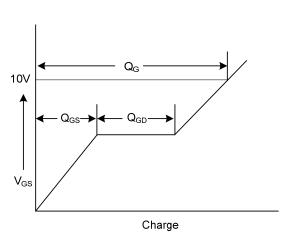


Power MOSFET

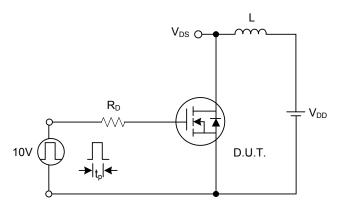
Switching Waveforms



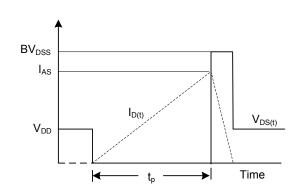
Gate Charge Test Circuit



Gate Charge Waveform

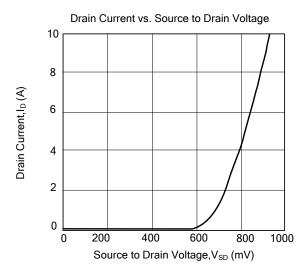


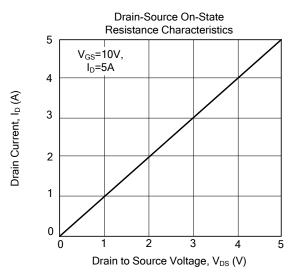
Unclamped Inductive Switching Test Circuit

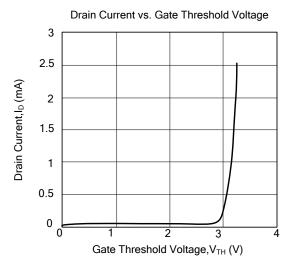


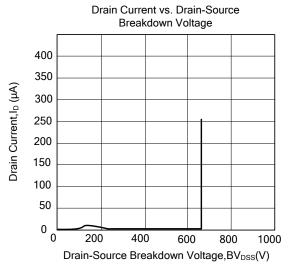
Unclamped Inductive Switching Waveforms

TYPICAL CHARACTERISTICS









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